

# **Technical Information**



## www.china-base.com.hk

### Index of Key Symbols

| В                            | Base connection                               | Kv                              | Thermal resistance correction factor               |
|------------------------------|---|---------------------------------|--|
| С                            | Capacitance; junction capacitance;            | $P_{tot}$                       | Power dissipation                                  |
|                              | Collector connection                          | $P_{o}$                         | Continuous power dissipation                       |
| C <sub>CBO</sub>             | Collector base capacitance (open emitter)     | $^{1}P_{1}$                     | Pulse power dissipation                            |
| $C_{EBO}$                    | Emitter base capacitance (open collector)     | r <sub>b</sub> . c <sub>c</sub> | Collector base time constant                       |
| $C_{iss}$                    | Input capacitance                             | r <sub>thA</sub>                | Pulse thermal resistance junction to ambient air   |
| E                            | Emitter connection                            | $\mathbf{r}_{\text{thC}}$       | Pulse thermal resistance junction to case          |
| f                            | Frequency                                     | R                               | Resistance; resistor                               |
| f <sub>r</sub>               | Gain bandwith product                         | $R_{_{BE}}$                     | Resistance between base and emitter                |
| F                            | Noise figure                                  | $R_{\!\scriptscriptstyle L}$    | Load resistance                                    |
| $F_c$                        | Noise figure in mixer stages                  | $R_s$                           | Series resistance                                  |
| h                            | Parameters of h-(hybrid) matrix               | $R_{th}$                        | Thermal resistance                                 |
| h <sub>f</sub>               | Small signal current gain                     | $R_{thA}$                       | Thermal resistance junction to ambient air         |
| $\mathbf{h}_{_{\mathrm{i}}}$ | Input impedance                               | $\mathbf{R}_{	ext{thC}}$        | Thermal resistance junction to case resp. mounting |
| $h_o$                        | Output admittance                             |                                 | base   |
| h <sub>r</sub>               | Reverse voltage transfer ratio                | $R_{\text{thC/S}}$              | Thermal resistance case or mounting base to heat   |
| h <sub>FE</sub>              | DC current gain, common emitter               |                                 | sink   |
| l <sup>B</sup>               | Base current                                  | $R_{ths}$                       | Thermal resistance heat sink to ambient air        |
| I <sub>BM</sub>              | Peak base current                             | t                               | Time   |
| I <sub>B1</sub>              | Turn-on current                               | t <sub>d</sub>                  | Delay time   |
| l <sub>B2</sub>              | Turn-off current                              | $\mathbf{t}_{_{\mathrm{f}}}$    | Fall time  |
| I <sub>c</sub>               | Collector current                             | t <sub>off</sub>                | Turn-off time (ts+tf)                              |
| I <sub>CAV</sub>             | Average collector current                     | t <sub>on</sub>                 | Turn-on time (td+tr)                               |
| I <sub>CBO</sub>             | Collector base cutoff current (open emitter)  | t <sub>p</sub>                  | Pulse duration                                     |
| I <sub>CEO</sub>             | Collector emitter cutoff current (open base)  | $t_{pd}$                        | Propagation delay time                             |
| I <sub>CER</sub>             | Collector emitter cutoff current (specified   | t,                              | Rise time  |
|                              | resistance between base and emitter)          | t <sub>s</sub>                  | Storage time                                       |
| I <sub>CES</sub>             | Collector emitter cutoff current (base short- | total                           | Total switching time (ton+toff)                    |
|                              | circuted to emitter)                          | T                               | Temperature; duration of one period                |
| ICEV                         | Collector emitter cutoff current (sepcified   | $T_{amb}$                       | Ambient temperature                                |
|                              | voltage between base and emitter)             | $T_{j}$                         | Junction temperature                               |
| I <sub>CM</sub>              | Peak collector current                        | $T_c$                           | Case temperature                                   |
| I <sup>E</sup>               | Emitter current                               | $T_{s}$                         | Storage temperature                                |
| l <sub>ebo</sub>             | Emitter base cutoff current (open collector)  | $T_{\mathtt{SB}}$               | Temperature of substrate backside                  |



## **Technical Information**



#### www.china-base.com.hk

#### Index of Key Symbols

V Voltage

V<sub>BB</sub> Base supply voltage

V<sub>BE</sub> Base emitter voltage

V<sub>BEsat</sub> Base emitter saturation voltage

V<sub>(BR)CBO</sub> Collect base breakdown voltage (open emitter)

V<sub>(BRICEO</sub> Collector emitter breakdown voltage (open base)

V<sub>(BR)CER</sub> Collector emitter breakdown voltage

(specified resistance between base and emitter)

V<sub>(BRICES</sub> Collector emitter breakdown voltage

(emitter short-circuited to base)

V<sub>(BR)EBO</sub> Emitter base breakdwon voltage (open collector)

V<sub>CB</sub> Collector base voltage

V<sub>CBO</sub> Collector base voltage (open emitter)

 $V_{CC}$  Collector supply voltage  $V_{CE}$  Collector emitter voltage

V<sub>CFO</sub> Collector emitter voltage (open base)

V<sub>CER</sub> Collector emitter voltage

(specified resistance between base and emitter)

V<sub>CFS</sub> Collector emitter voltage (emitter short-circuit to base)

V<sub>CFest</sub> Collector emitter saturation voltage

V<sub>CEV</sub> Collector emitter voltage

(specified voltage between base and emitter)

V<sub>EBO</sub> Emitter base voltage (open collector)

V<sub>FF</sub> Emitter supply voltage

V<sub>i</sub> Input voltage

V Output voltage

T<sub>s</sub> Storage time constant

ν Duty cycle (tp/T)